

October 2001 Revised October 2001

74ALVC16245

Low Voltage 16-Bit Bidirectional Transceiver with 3.6V Tolerant Inputs and Outputs

General Description

The ALVC16245 contains sixteen non-inverting bidirectional buffers with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. Each byte has separate 3-STATE control inputs which can be shorted together for full 16-bit operation. The T/\overline{R} inputs determine the direction of data flow through the device. The \overline{OE} inputs disable both the A and B ports by placing them in a high impedance state.

The 74ALVC16245 is designed for low voltage (1.65V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The 74ALVC16245 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.65V-3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- tor

3.0 ns max for 3.0V to 3.6V V_{CC} 3.5 ns max for 2.3V to 2.7V V_{CC} 6.0 ns max for 1.65V to 1.95V V_{CC}

- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- Uses patented noise/EMI reduction circuitry
- Latchup conforms to JEDEC JED78
- ESD performance:

Human body model > 2000V Machine model > 200V

■ Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

Note 1: To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

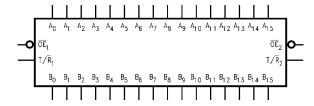
Ordering Code:

Order Number	Package Number	Package Description
74ALVC16245GX (Note 2)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [TAPE and REEL]
74ALVC16245MTD (Note 3)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Note 2: BGA package available in Tape and Reel only.

Note 3: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagrams

T/R_t - OE₁ Во -- A₀ В, GND -- GND В2 -- A₂ − v_{cc} - A4

Pin Assignment of TSSOP

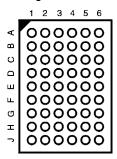
- GND 38 **-** △6 - A₇ — A₈ — A₉ 34 — GND 33 - A₁₀ 32 A₁₁ 31 - V_{CC} — A_{1 2} 30 В₁₂ -⊢ A_{1 3} B₁₃ -28 - GND GND -

Pin Assignment for FBGA

B₁₄ -

27

- A₁₄ − 0E₂



(Top Thru View)

Pin Descriptions

Pin Names	Description				
OE _n	Output Enable Input (Active LOW)				
T/R _n	Transmit/Receive Input				
A ₀ -A ₁₅	Side A Inputs or 3-STATE Outputs				
A ₀ -A ₁₅ B ₀ -B ₁₅	Side B Inputs or 3-STATE Outputs				
NC	No Connect				

FBGA Pin Assignments

	1	2	3	4	5	6
Α	B ₀	NC	T/R ₁	OE ₁	NC	A ₀
В	B ₂	B ₁	NC	NC	A ₁	A ₂
С	B ₄	B ₃	V _{CC}	V _{CC}	A ₃	A ₄
D	B ₆	B ₅	GND	GND	A ₅	A ₆
E	B ₈	B ₇	GND	GND	A ₇	A ₈
F	B ₁₀	B ₉	GND	GND	A ₉	A ₁₀
G	B ₁₂	B ₁₁	V _{CC}	V _{CC}	A ₁₁	A ₁₂
Н	B ₁₄	B ₁₃	NC	NC	A ₁₃	A ₁₄
J	B ₁₅	NC	T/R ₂	OE ₂	NC	A ₁₅

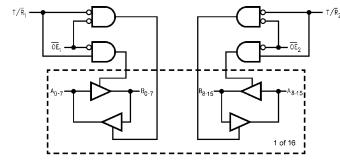
Truth Tables

Inputs		Outroot-	
OE ₁	T/R ₁	Outputs	
L	L	Bus B ₀ –B ₇ Data to Bus A ₀ –A ₇	
L	Н	Bus A ₀ -A ₇ Data to Bus B ₀ -B ₇	
Н	X	HIGH Z State on A ₀ -A ₇ , B ₀ -B ₇	

Inputs		0.44.
OE ₂	T/R ₂	Outputs
L	L	Bus B ₈ -B ₁₅ Data to Bus A ₈ -A ₁₅
L	Н	Bus A ₈ -A ₁₅ Data to Bus B ₈ -B ₁₅
Н	X	HIGH Z State on A ₈ -A ₁₅ , B ₈ -B ₁₅

- H = HIGH Voltage Level
- L = LOW Voltage Level
 X = Immaterial (HIGH or LOW, inputs and I/O's may not float)
- Z = High Impedance

Logic Diagram



Absolute Maximum Ratings(Note 4)

 $\begin{tabular}{lll} Supply Voltage (V_{CC}) & -0.5V to +4.6V \\ DC Input Voltage (V_I) & -0.5V to 4.6V \\ \end{tabular}$

Output Voltage (V $_{\rm O}$) (Note 5) $-0.5 \mbox{V to V}_{\rm CC}$ +0.5V

DC Input Diode Current (I_{IK})

 $V_1 < 0V$ -50 mA

DC Output Diode Current (I_{OK})

V_O < 0V

DC Output Source/Sink Current
(I_{OH}/I_{OL})

DC V_{CC} or GND Current per

Supply Pin (I_{CC} or GND) ±100 mA

Storage Temperature Range (T_{STG}) $-65^{\circ}C$ to $+150^{\circ}C$

Recommended Operating Conditions (Note 6)

Power Supply

-50 mA

±50 mA

 $\begin{tabular}{ll} Operating & 1.65 V to 3.6 V \\ Input Voltage & 0 V to V_{CC} \end{tabular}$

Minimum Input Edge Rate (Δt/ΔV)

 $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$ 10 ns/V

Note 4: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 5: I_O Absolute Maximum Rating must be observed.

Note 6: Floating or unused control inputs must be held HIGH or LOW.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage		1.65 - 1.95	0.65 x V _{CC}		
			2.3 - 2.7	1.7		V
			2.7 - 3.6	2.0		i
V _{IL}	LOW Level Input Voltage		1.65 - 1.95		0.35 x V _{CC}	
			2.3 - 2.7		0.7	V
			2.7 - 3.6		0.8	1
V _{OH}	HIGH Level Output Voltage	I _{OH} = -100 μA	1.65 - 3.6	V _{CC} - 0.2		
		$I_{OH} = -4 \text{ mA}$	1.65	1.2		1
		$I_{OH} = -6 \text{ mA}$	2.3	2.0		i
		$I_{OH} = -12 \text{ mA}$	2.3	1.7		V
			2.7	2.2		i.
			3.0	2.4		1
		$I_{OH} = -24 \text{ mA}$	3.0	2		1
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	1.65 - 3.6		0.2	
		I _{OL} = 4 mA	1.65		0.45	i
		I _{OL} = 6 mA	2.3		0.4	V
		I _{OL} = 12 mA	2.3		0.7	V
			2.7		0.4	i
		I _{OL} = 24 mA	3.0		0.55	i
I _I	Input Leakage Current	0 ≤ V _I ≤ 3.6V	3.6		±5.0	μΑ
I _{OZ}	3-STATE Output Leakage	0 ≤ V _O ≤ 3.6V	3.6		±10	μΑ
Icc	Quiescent Supply Current	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6		40	μΑ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	3 - 3.6		750	μА

AC Electrical Characteristics

Symbol	Parameter	$T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, R_L = 500\Omega$								
		C _L = 50 pF			C _L = 30 pF					
Oyillboi		$V_{CC} = 3.3V \pm 0.3V$		V _{CC} = 2.7V V		$\textrm{V}_{\textrm{CC}}=\textrm{2.5V}\pm\textrm{0.2V}$		$V_{CC} = 1.8V \pm 0.15V$		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t _{PHL} , t _{PLH}	Propagation Delay	1.3	3	1.5	3.5	1.0	3.0	1.5	6.0	ns
t _{PZL} , t _{PZH}	Output Enable Time	1.3	4.3	1.5	5.4	1.0	4.9	1.5	9.3	ns
t _{PLZ} , t _{PHZ}	Output Disable Time	1.3	4.2	1.5	4.7	1.0	4.2	1.5	7.6	ns

Capacitance

Symbol	Parameter		Conditions	T _A = -	Units	
Symbol	Farameter		Conditions	V _{CC}	Typical	Units
C _{IN}	Input Capacitance		V _I = 0V or V _{CC}	3.3	6	pF
C _{IO}	Input, Output Capacitance		$V_O = 0V$ or V_{CC}	3.3	7	pF
C _{PD}	Power Dissipation Capacitance Outputs Enabled		f = 10 MHz, C _L = 50 pF	3.3	20	pF
				2.5	20	ρı

AC Loading and Waveforms

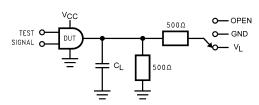


TABLE 1. Values for Figure 1

TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t_{PZL}, t_{PLZ}	V_{L}
t_{PZH} , t_{PHZ}	GND

FIGURE 1. AC Test Circuit

TABLE 2. Variable Matrix (Input Characteristics: f = 1MHz; $t_r=t_f=2ns;\ Z_O=50\Omega)$

Symbol	V _{CC}						
- Cyllibor	3.3V ± 0.3V	2.7V	2.5 ± 0.2V	1.8V ± 0.15V			
V _{mi}	1.5V	1.5V	V _{CC} /2	V _{CC} /2			
V _{mo}	1.5V	1.5V	V _{CC} /2	V _{CC} /2			
V _X	V _{OL} + 0.3V	V _{OL} + 0.3V	V _{OL} + 0.15V	V _{OL} + 0.15V			
V _Y	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V	V _{OH} – 0.15V			
V_L	6V	6V	V _{CC} *2	V _{CC} *2			

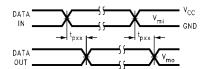


FIGURE 2. Waveform for Inverting and Non-inverting Functions

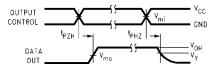


FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

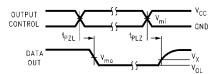
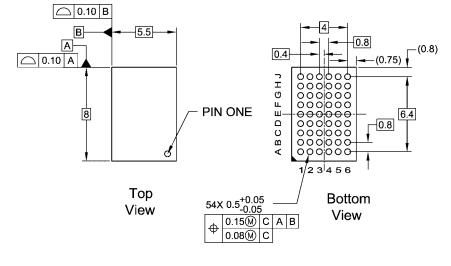
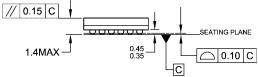


FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

Physical Dimensions inches (millimeters) unless otherwise noted



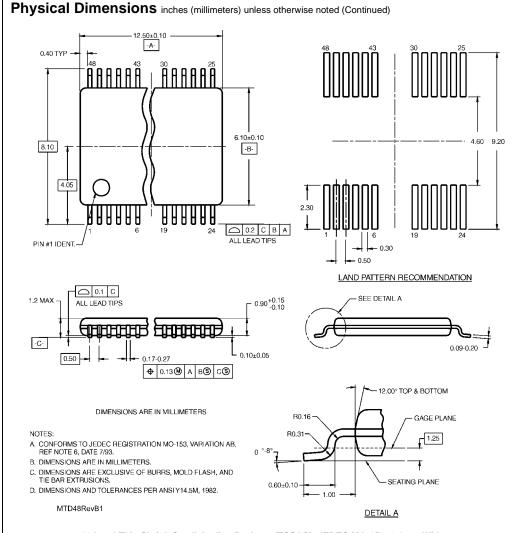


NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC M0-205
- B. ALL DIMENSIONS IN MILLIMETERS
- C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
 .35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
 D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA54ArevD

54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide Package Number BGA54A



48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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